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(54) MICRO-FLUIDIC MODULES ON A CHIP FOR DIAGNOSTIC APPLICATIONS

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(57) ABSTRACT

A micro-fluidic device includes a plurality of heaters on a substrate for heating the substrate. The plurality of heaters define a plurality of temperature regions having distinct temperatures on the substrate. A flow feature layer is formed above the substrate to define a channel extending across the substrate through each temperature region. As fluid is repeatedly pumped within the channel, it flows from one temperature region to a next temperature region to undergo thermal cycling.

3 Claims, 10 Drawing Sheets



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Figure 1





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Figure 4







Figure 8





Figure 10



Figure 11



Figure 12





Figure 14







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MICRO-FLUIDIC MODULES ON A CHIP FOR **DIAGNOSTIC APPLICATIONS**

FIELD OF THE INVENTION

The present invention relates to micro-fluid applications. More particularly, it relates to point-of-care and lab-on-a-chip devices having functional modules that enable diagnostic solutions.

BACKGROUND

Various diagnostic platforms utilize thermal cycling processes which involve heating of reagents at different temperatures to alter certain properties of the reagents. An example 15 application is Polymerase Chain Reaction (PCR) which is a method used to amplify genetic material for detection and analysis. Analysis speed is especially important in diagnostic applications. For example, shorter analysis time would allow faster turnaround time in identifying infectious diseases, or 20 enable the analysis to take place in the time it takes for a physician's appointment.

Thermal cycling methods generally fall under two categories: stationary and continuous flow. Stationary systems conduct thermal cycling by holding a fixed volume of sample 25 fluid and/or reagents stationary in a chamber while varying the temperature of the chamber to alternately heat and cool the reagents. A disadvantage of this kind of thermal cycling is reduced amplification efficiency due to heating and cooling ramping rates associated with varying the chamber tempera- 30 ture during each cycle. Continuous flow systems, on the other hand, conduct thermal cycling by allowing fluid samples to flow through different temperature regions. In particular, each temperature region maintains a distinct temperature and reagents are allowed to pass through the temperature regions 35 for a number of cycles by propelling them, using pumps, to flow through a long channel having sections formed on each temperature region. Delay in inter-temperature transition time can be reduced by controlling the flow rate of fluids within the channel. As a result, continuous flow systems can 40 shorten analysis times compared to stationary thermal cycling.

A number of micro-fluidic approaches to diagnostic applications utilizing continuous flow thermal cycling have been developed for lab-on-a-chip and point-of-care devices. 45 Micro-fluidic devices manipulate microscopic volumes of liquid inside micro-sized structures. As such, it can provide advantages over conventional and non-micro-fluidic based techniques such as smaller sample volumes, greater efficiency of chemical reagents, high speed analysis, high 50 shown in FIG. 2; throughput, portability and low production costs per device allowing for disposability.

Micro-fluidic modules can be built by combining several components like channels, connectors, filters, mixers, heaters, sensors, micro-valves, micro-fluidic pumps, and etc. 55 Among these components, it is well known to be difficult to attain micro-fluidic pumps which are ready to be assembled with micro-fluidic devices at low costs. For example, while a range of micro-fluidic devices have been miniaturized to the size of a postage stamp, these devices have often required 60 each temperature region of the PCR device in FIG. 1, relative large external pumping systems for fluid transport through channels. Unfortunately, the inclusion of these external pumps presents added complexity in coupling with fluidic channels, and also often increases the overall size of the micro-fluidic system.

Thus, there is a need for a micro-fluidic system which integrates together functional modules, such as pumps and micro-fluidic structures, to provide reliable and even smaller device footprint for point-of-care diagnostic and lab-on-achip applications. Additional benefits and alternatives are also sought when devising solutions.

SUMMARY

The above-mentioned and other problems become solved by forming pump modules and fluidic structures monolithi-¹⁰ cally on a substrate to provide a micro-fluidic system on a chip. Example embodiments utilize heater chip fabrication methods to achieve results.

In a representative embodiment, a micro-fluidic device includes a substrate and a plurality of heaters on the substrate for heating the substrate. The plurality of heaters define a plurality of temperature regions on the substrate, each temperature region having a distinct temperature. A flow feature layer formed above the substrate defines a channel that extends across the substrate through each temperature region so that when fluid is pumped within the channel, it flows from one temperature region to a next temperature region to undergo repeated heating and cooling. Repeated heating and cooling of fluids as pumping is continued thermally cycles the fluid.

In an example aspect, at least one pump is disposed along the channel for pumping fluid in the channel. In another example aspect, at least one trench is formed from a backside to a top surface of the substrate, and extended between adjacent temperature regions to thermally isolate the temperature regions from each other. In yet another example aspect, a heat sink is mounted beneath the substrate to collect heat residue between adjacent temperature regions so as to reduce temperature gradients therebetween.

These and other embodiments are set forth in the description below. Their advantages and features will become readily apparent to skilled artisans. The claims set forth particular limitations.

BRIEF DESCRIPTION OF THE DRAWINGS

The accompanying drawings incorporated in and forming a part of the specification, illustrate several aspects of the present invention, and together with the description serve to explain the principles of the invention. In the drawings:

FIG. 1 is a perspective view of a micro-fluidic continuous flow PCR device, according to an example embodiment;

FIG. 2 is a top view of the PCR device in FIG. 1:

FIG. 3 is a schematic view of a micro-fluidic pump;

FIG. 4 illustrates a top view of a portion of the PCR device

FIG. 5 shows a stack structure of the PCR device in FIG. 1 taken along line 5-5 of FIG. 4;

FIG. 6 is a schematic diagram of an on-chip thermal control system on the PCR device of FIG. 1, according to an example embodiment;

FIG. 7 is a top view of the PCR device in FIG. 1 showing temperature sensors disposed on different temperature regions and zones of the PCR device;

FIG. 8 is a simulation chart illustrating temperatures of to time;

FIG. 9 is schematic view of a PCR device, according to another example embodiment;

FIG. 10 illustrates a top view of a portion of the PCR device 65 in FIG. 9;

FIG. 11 shows a stack structure of the PCR device taken along line 11-11 of FIG. 10;

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FIG. 12 is a schematic diagram of an on-chip thermal control system on the PCR device of FIG. 9, according to an example embodiment:

FIG. 13 is a top view of the PCR device in FIG. 9 showing temperature sensors disposed on different thermal regions;

FIG. 14 is a simulation chart illustrating temperatures of each thermal region of the PCR device in FIG. 9, relative to time

FIG. 15 is a diagram of a PCR device mounted as a labon-a-chip device, according to an example embodiment; and 10

FIG. 16 is a diagram of a PCR device mounted as a labon-a-chip device, according to another example embodiment.

DETAILED DESCRIPTION OF THE ILLUSTRATED EMBODIMENTS

In the following detailed description, reference is made to the accompanying drawings where like numerals represent like details. The embodiments are described in sufficient detail to enable those skilled in the art to practice the inven- 20 tion. It is to be understood that other embodiments may be utilized and that process, electrical, and mechanical changes, etc., may be made without departing from the scope of the invention. The following detailed description, therefore, is not to be taken in a limiting sense and the scope of the 25 invention is defined only by the appended claims and their equivalents. In accordance with the features of the invention, a micro-fluidic system for thermal cycling integrates pump modules and fluidic structures on a single chip to enable diagnostic solutions. The modules are monolithically fabri- 30 cated on a substrate using inkjet technology and heater chip fabrication techniques. In the following embodiments, representative diagnostic solutions contemplate a case study for polymerase chain reaction (PCR).

PCR is a process by which genetic material, such as DNA, 35 is amplified exponentially for detection and analysis. PCR relies on cycling a mixture of ingredients including DNA sample, primers, and enzymes used for DNA synthesis, among others, through a series of repeated temperature changes, called cycles, to repeatedly heat and cool the mix- 40 ture of ingredients. Typically, PCR has three thermal control steps/points for each cycle: denaturing, hybridization/annealing, and extension. During denaturing, a heating temperature above 90° C., such as from about 94° C. to about 98° C., breaks a double-stranded DNA molecule into two comple- 45 mentary single-stranded DNA molecules. In the annealing step, the single-stranded DNA molecules are cooled at a lower temperature from about 50° C. to about 65° C., such as about 60° C., to allow DNA synthesis whereby the singlestranded DNA molecules seek their complementary strands 50 (designed primer) to create incomplete double-stranded DNA molecules. During the extension step, reactions are heated at a heating temperature above 65° C., such as from about 70° C. to about 75° C., so that the incomplete double-stranded DNA molecules are extended with the help of an enzyme called 55 DNA polymerase. The cycle is then repeated a number of times to achieve a desired amount of amplification of the DNA material.

Referring now to FIGS. 1 and 2, there is illustrated an example embodiment of a micro-fluidic device and, more 60 particularly, a continuous flow PCR (CF-PCR) device 10. CF-PCR device 10 includes a substrate 15, a heater layer 20, a flow feature layer 25 defining fluidic structures above the heater layer 20, and a cover layer 30 over the flow feature layer 25. The flow feature layer 25 defines walls and together 65 with the cover layer 30 forms a channel 35 in which fluid flows. The channel 35 defines a serpentine channel having a

plurality of cycles 35-1, 35-2, ..., 35-n that extend along the length of CF-PCR device 10 through three distinct temperature regions 40A, 40B, and 40C, each region 40 for denaturation, annealing, and extension thermal control points of a PCR process, respectively. The temperature regions 40 are heated using heater elements formed and emplaced variously on heater layer 20 within each region 40, and are thermally isolated from each other by trenches 45 formed on the substrate 20 between each region 40, as will be explained in more detail below. Inlets 50 and outlets 55 formed at the ends of channel 35 serve to introduce and remove fluid from the channel 35. Any number of inlets and outlets can be formed.

Pumps 60 are disposed along portions of channel 35 to propel fluid to flow the channel. In an example embodiment, 15 each of pumps 60 includes a plurality of resistive heaters 65 (65-1, 65-2, ..., 65-*n*) formed on heater layer 20 and along a corresponding channel portion, as shown in FIG. 3, to form a thermal bubble pump. In operation, by applying a voltage pulse to each of the heaters 65 of pumps 60, thermal bubbles are formed in a predetermined manner. For example, every heater 65 of pump 60 can form a bubble from the left to the right of the channel in sequence to push the liquid in the same direction. This cycle is then repeated to continue the pumping. Pumps of this type are the ones disclosed in more detail in U.S. patent application Ser. No. 13/556,495, filed Jul. 24, 2012, entitled "Micro-Fluidic Pump" and assigned to the assignee of the present invention. The disclosure of this patent is hereby incorporated herein by reference. As liquid is pumped through the channel 35, it repeatedly passes through the different temperature regions 40 for a number of cycles n to undergo thermal cycling. The residence time of a PCR reaction mixture within a temperature region 40 depends on the length of the channel within the region and the flow rate of the reaction within the channel 35. Accordingly, pumps 60 can be controlled to adjust the flow rate to achieve desired residence time.

FIG. 4 illustrates a top view of a portion of CF-PCR device 10 with the cover layer 30 removed to show at least a cycle of the underlying channel 35, and FIG. 5 shows a stack structure of the CF-PCR device 10 taken along line 5-5 of FIG. 4. In FIG. 4, a plurality of heating elements 70 associated with each temperature region 40 are disposed at areas surrounding the channel 35, and trenches 45 are formed between temperature regions 40 for thermal isolation. By not disposing heating elements 70 along the channel 35, unequal heating of fluids within the channel can be avoided. Instead, fluids within each region 40 can be heated substantially equivalently or uniformly by allowing heat of the substrate to act on them, as will be explained in detail below. It will be appreciated that the depicted arrangement of heating elements 70 is only for purposes of illustration and thus should not be considered limiting, and that any number of heater elements and arrangement thereof on the substrate 15 can be used.

In FIG. 5, the stack shows heating elements 70 formed on the heater layer 20 above the substrate 15, a support material 75 surrounding the heating elements 70 to serve as underlying support for the channel 35, flow feature layer 25 formed above the heating elements 70 and support material 75, cover layer 30 formed above flow feature layer 25, trenches 45 etched from a backside 15A of the substrate 15 to a top surface 15B thereof, and a heat sink 80 beneath the substrate 15. (It should be noted that FIG. 5 is not an exact cross sectional view of FIG. 4. That is, cover layer 30 is present in FIG. 5 and the heating elements 70 are projected towards the cross sectional area such that they appear directly below the channel 35. Additionally, heat sink 80 which is not shown in FIG. 1 is shown in FIG. 5.)

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The heating elements 70 are in thermal contact with the substrate 15 and the substrate 15 should be thermally conductive to dissipate heat from the heating elements 70. In operation, heat generated by the heater elements 70 travel through the substrate 15 and spreads out to each corresponding temperature region 40. Vertical heat flow from the substrate 15 dominates the temperature of the regions 40 and is used to heat fluids flowing through corresponding channels above the substrate 15. Trenches 45 serve to interrupt the travel of heat between temperature regions 40 to provide thermal stability. 10 Additionally, heat sink 80 helps hold the lateral region to region heat flow to a minimum. In particular, with differing temperatures applied to each temperature region 40, a temperature gradient can be formed between adjacent temperature regions. Heat sink 80 collects heat residue between adja- 15 cent temperature regions 40 in order to substantially minimize the temperature gradient between regions.

Referring now to FIG. 6, there is illustrated an on-chip thermal control system 100 that can be implemented integrally with CF-PCR device 10 and used to control each tem- 20 perature region 40 to provide specific temperatures required for each thermal control point for PCR, in accordance with an example embodiment of the present invention. Generally, thermal control system 100 is used to sense the temperature of a temperature region 40 and limit temperature variations at 25 desired levels. A number of the thermal control system 100 can be provided on CF-PCR device 10 to provide coverage for each of the temperature regions 40.

More particularly, for each temperature region 40, a thermal control system 100 includes a preset temperature refer-30 ence source 105. Preset temperature reference source 105 can be an 8 bit digital to analog converter (DAC) connected to a serial peripheral interface, for example, that provides a desired temperature set point current input I(set) used to set the target temperature for a corresponding temperature region 35 40. Thermal control system 100 also includes at least one temperature sensor 110 that senses and provides actual substrate temperature readings in the form of a current input I(sense). Temperature sensor 110 can be an active circuit composed of CMOS transistors and substrate PNP which 40 produces an output current proportional to absolute temperature sensed. In FIG. 5, temperature sensors 110 are shown as being formed on substrate 15 for each temperature region 40.

To provide more accurate temperature coverage of an entire length of a temperature region **40**, each temperature 45 region **40** may be divided into a plurality of zones with each zone having an associated temperature sensor. For example, as shown in FIG. **7**, each temperature region **40** is divided into three zones Z-**1**, Z-**2**, Z-**3** sensed by corresponding temperature sensors **110**. Of course, each region can be divided into 50 any number of zones. A calibration sink **115** may be provided to adjust for variations between zone temperature sensors **110** of each temperature region **40**. In particular, calibration sink **115** may generate a calibration source current I(cal) from which each of the temperature sensors **110** of a region **40** may 55 be calibrated. Accordingly, temperature sensors **110** associated with each temperature region **40** may read the same value for the same temperature after calibration.

Once the temperature sensors **110** are calibrated, the preset temperature reference current input I(set) is used to set the 60 target temperature of each zone Z via a preset temperature sink **120**. In particular, current input I(sense) from temperature sensor **110** and current input I(set) from preset temperature sink **120** combine to produce a current output I(diff) which is the difference between the current inputs. Essentially, current output I(diff) represents a difference between the target temperature and the temperature sensed by the 6

temperature sensor **110**. A pulse width modulation (PWM) generator **125** receives the current output I(diff) and outputs a pulse width modulated heat pulse PWM(heat) that is proportional to the current output I(diff). An AND gate **130** receives the heat pulse PWM(heat) at its input **130**A. The other input **130**B of AND gate **130** can be an enable signal for heating.

In an example embodiment, PWM generator **125** can be controlled to provide a set of quantized PWM signals during an initial thelinal ramp up to a set point temperature. For example, PWM generator **125** could have a 5 phase quantized PWM signal having pulses with duty cycles of 100%, 75%, 50%, 25%, and 0%, during the initial ramp. The duty cycle is proportional to the current output I(diff) as discussed above. In this way, a smaller delay before reaching the set point temperature can be achieved.

Thermal control system 100 further includes a switch 140 connected to an output 130C of AND gate 130. The gates of switch 140 are driven by drive pulses P(drive) so that it periodically activates a connected heater element 70 to produce heat pulses that are delivered to the substrate 15. Heat then spreads throughout the substrate temperature region. Process then loops until the current I(sense) at each temperature sensor 110 is equal to the desired set current I(set) of the preset temperature for the temperature region 40. Accordingly, when the current input I(sense) from the temperature sensor 110 substantially equals the current I(set) from the preset temperature sink 120, the region is at its target temperature.

Thermal isolation structures, i.e., trenches **45**, and heat sink **80** provide added stability in the thermal control. FIG. **8** shows a simulation chart illustrating temperatures of each of the regions **40** with respect to time. As shown, temperatures for each temperature region **40** are effectively maintained substantially linear after initial ramp. Additionally, temperature gradient along each temperature region **40** is kept minimal as indicated by the marginal deviation of thermal zone temperatures along each temperature region **40**. Thus, the thermal control system **100** allows each temperature region **40** to be thermally stable within the range of its corresponding set point temperature.

CF-PCR device 10 is fabricated on substrate 15. The preferred substrate is silicon, which allows forming logic circuits together with the pumps and micro-fluidic structures. In addition, silicon provides high thermal conductivity to conduct heat from the heaters and heat fluids above it. The heating elements 70 associated with each region 40 and resistive heaters 65 associated with each pump 60 are formed by layers or films of semiconductor and other suitable materials formed or deposited, by using known micro-electronic fabrication techniques, on the substrate 15. For example, such heater elements 70 can be constructed in a similar fashion as the resistive heaters 65 as disclosed in U.S. Pat. No. 8,172,369, the contents of which are hereby incorporated by reference. Logic circuits to control heaters are formed on the substrate 15 by silicon processing. The heaters are then formed with the fluidic structures. A silicon dioxide is grown or deposited as the support material 75 on top of the substrate 15 (and alternatively over the heaters). A photoimageable polymer, for example, SU-8 (MicroChem, Newton, Mass.), is used to form the flow feature layer 25. For the cover layer 30, a photoimageable dry film, for example, VACRELTM (DuPont) is used and applied onto the flow feature by a lamination process. Inlet and outlet ports that align with inlets 50 and outlets 55 can be formed by either deep reactive ion etching (DRIE) or a photolithography process. By DRIE, an inlet port and an outlet port can be formed by etching holes through the substrate. In this case, liquid is fed into inlets **55** and the channel **35** from the backside of the substrate **15**. An inlet port and an outlet port can be formed on the top side of the CF-PCR device **10** by patterning the flow feature **25** and cover layer **30**. In addition, both DRIE and photolithography processes can 5 be used to make an inlet port on the top side and outlet port on the backside of the CF-PCR device **10**. A highly thermal conductive material, such as Al, aluminum alloys, Cu, diamond or composite materials like copper-tungsten, can be used for heat sink **80** beneath substrate **15**.

Referring now to FIG. 9, another example embodiment of a micro-fluidic PCR device 210 is illustrated. Generally, PCR device 210 is fabricated using the same fabrication techniques as the CF-PCR device 10 discussed above, but with fluidic structures patterned to form a looped channel 235 containing 15 a plurality of wells 237 formed on three thermal regions 240A, 240B, 240C, each region for denaturation, annealing, and extension thermal control points of a PCR process, respectively. Any number of wells for each region 240 can be utilized, depending on the design contemplated. The thermal 20 regions 240 are heated using heater elements formed and emplaced variously within each region 240 and are thermally isolated from each other by trenches 245 formed between each thermal region 240. Inlet 250 and outlet 255 formed at the ends of looped channel 235 serve to introduce and remove 25 fluid from the looped channel 35. A plurality of pumps 260 are disposed along portions of the fluidic structures of channel 235 to propel fluid.

In operation, fluids are propelled by pumps 260 through the looped channel 235 to pass through each of the thermal regions 240 to complete one thermal cycle. Depending on the required heating time, PCR reaction mixtures can be allowed to dwell within wells 237 of a thermal region 240 by deactivating pumps 260. Pumping can be continued to allow PCR reaction mixtures to repeatedly pass through the different 35 thermal regions 240 for a required number of cycles depending on the amount of amplification desired. Pumps 260 can be controlled to pump fluids in a coordinated manner to properly direct fluid flow to desired fluid paths. For example, pumps 260A and 260B can be controlled to push fluids from left to 40 right along channel portions 235A and 235B, respectively, while pump 260C is controlled to push fluids from right to left along a channel portion 235C to compel fluids within well 237 of thermal region 240A to flow towards channel portion 235B. Meanwhile, as pump 260B along channel portion 45 235B is controlled to push fluids from left to right, pumps 260D and 260E along channel portions 235D and 235E, respectively, can be controlled to push fluids from right to left to prevent fluids from flowing into outlet 255 and instead compel fluids within the wells 237 of thermal region 240B to 50 flow towards channel portion 235F. To allow fluid flow into outlet 255, at least each of pumps 260B, 260D, and 260E can be controlled to push fluid from left to right to compel fluid within wells 237 of thermal region 240B to flow into outlet 255. As will be appreciated, other techniques for controlling 55 the pumps to convey fluids within the channel can be implemented.

FIG. 10 illustrates a top view of a portion of PCR device 210 and FIG. 11 shows a stack structure of PCR device 210 taken along line 11-11 of FIG. 10. In FIG. 10, a plurality of 60 heating elements 270 are disposed at areas surrounding the well 237 to define a thermal region 240. Different arrangements of heating elements can be utilized. Trenches 245 are also formed to thermally isolate the thermal regions 240. In FIG. 11, the stack shows heating elements 270 formed above 65 and in thermal contact with a substrate 215, a support material 275 surrounding the heating elements 270 to serve as under8

lying support for the channels 235 and wells 237, a flow feature layer 225 formed above the heating elements 270 and support material 275 to provide upstanding walls for the channel, cover layer 230 formed above flow feature layer 225, trenches 245 etched from a backside 215A to a top surface 215B of the substrate 215 (and alternatively further through the support material 275 and the flow feature layer 225), and a heat sink 280 beneath the substrate 215. (It should be noted that FIG. 11 is not an exact cross sectional view of FIG. 10. That is, cover layer 230 above the flow feature layer 225 if illustrated in FIG. 10 would prevent the illustration of the underlying well 237. Hence, the cover layer 230 is not present in FIG. 10. In addition the heating elements 270 are projected towards the cross sectional area such that they appear directly below the well 237.) As previously mentioned, the heating elements 270, substrate 215, trenches 245, heat sink 280, and other similar components may be constructed in the same fashion and serve to provide the same functions as in the CF-PCR device 10 embodiment, the differences only being the pattern of the fluidic structures, location of the thermal regions and/or trenches, and specific pump functions.

Referring now to FIG. 12, there is illustrated an on-chip thermal control system 300 that can be implemented integrally with PCR device 210 for each thermal region 240 to provide specific temperatures required for each thermal control point for PCR, in accordance with an example embodiment of the present invention. It should be noted, however, that the thermal control system 100 previously described can also be used for PCR device 210. Conversely, thermal control system 300 can also be used for CF-PCR device 10.

Thermal control system 300 includes a temperature set point register 305 for holding a binary value B(set) corresponding to a target temperature. Thermal control system 305 also includes at least one temperature sensor 310 that senses and provides actual substrate temperature readings of a thermal region. Temperature sensor 310 can be an active circuit composed of CMOS transistors and substrate PNP which produces an output current I(sense) proportional to absolute temperature sensors. In FIG. 11, a temperature sensor 310 is shown as being formed on substrate 215. Any number of temperature sensors can be used for each thermal region to provide more accurate coverage. For example, as shown in FIG. 13, each of thermal regions 240B and 240C has two associated temperature sensors 310 defining thermal zones within each region.

Thermal control system 300 further includes an analog to digital converter (ADC) 315 that receives I(sense) from temperature sensor 310. ADC 315 can be an 8 bit ADC that samples and cycles through each thermal zone, sampling the output current I(sense) of temperature sensor 310 and converting it to an 8-bit binary value B(sense). A subtractor 320, which can be a 2's complement subtractor, receives as inputs the target temperature binary value B(set) from the temperature set point register 305 and the binary value B(sense) from ADC 315, and returns a value B(diff) that corresponds to the difference between the two inputs to a quantizer 325. Essentially, output B(diff) represents a difference between the target temperature and the temperature sensed by the temperature sensor 310. Quantizer 325 converts the difference output B(diff) of substractor 320 to a quantized PWM output P(drive) whose width is proportional to the difference output B(diff). The quantized PWM output P(drive) of quantizer 325 is then used to drive a switch 330 so that it periodically activates a connected heater element 270 to produce heat pulses that are delivered to the substrate 215. Heat spreads through the substrate thermal regions and the process loops until the binary value corresponding to the current I(sense) at

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temperature sensor 310 is equal to the binary value of the register 305 which corresponds to the target temperature for the thermal region. When B(sense) substantially equals B(set), the thermal region is at its target temperature.

FIG. **14** shows a simulation chart illustrating temperatures ⁵ of each of the thermal regions **240** with respect to time. As shown, temperatures for each thermal region **240** are effectively maintained substantially linear after initial ramp. Additionally, temperature gradient along each thermal region **240** is kept minimal as indicated by the marginal deviation of ¹⁰ temperatures at arbitrary points selected in the top, bottom, and middle areas of a well for each thermal region **240**.

FIG. 15 shows an embodiment of a micro-fluidic PCR device 400, which can either be CF-PCR device 10 or PCR device 210, mounted on a lab-on-a-chip device 410. PCR ¹⁵ device 400 has a channel 412, and inlet 415 and outlet 420 aligned with an inlet port 425 and an outlet port 430, respectively, formed through the substrate. Inlet port 425 and outlet port 430 are aligned and disposed on port holes 435 and 440, respectively, of the lab-on-a-chip device 410. A pressure sen-²⁰ sitive adhesive or an epoxy adhesive can be used to bond the PCR device 400 on the chip 410.

In another embodiment, a micro-fluidic PCR device **500** can have a top-side inlet **515** and bottom-side outlet **520**, as shown in FIG. **16**. The top-side inlet **515** aligns with an inlet ²⁵ port **525** formed by opening up the cover layer. On the other hand, DRIE of silicon can be used to form bottom-side outlet port **530** aligned with the outlet **520**. PCR device **500** can be mounted on a lab-on-a-chip device **510**. The outlet port **530** of PCR device **500** are aligned and disposed on a port hole **535** ³⁰ of the lab-on-a-chip **510**. A liquid container **540** adjacent the inlet port **525** can be attached to introduce fluid into the inlet **515** and the channel **412**.

Thus, micro-fluidic devices for point-of-care diagnostic and lab-on-a-chip applications are disclosed. The foregoing illustrates various aspects of the invention. It is not intended to be exhaustive. Rather, it is chosen to provide the best illustration of the principles of the invention and its practical application to enable one of ordinary skill in the art to utilize the invention, including its various modifications that naturally follow. All modifications and variations are contemplated within the scope of the invention as determined by the appended claims. Relatively apparent modifications include combining one or more features of various embodiments with features of other embodiments.

The invention claimed is:

- 1. A micro-fluidic device, comprising:
- a substrate having a top surface and a backside defining a thickness thereof;
- a trench extending through an entirety of the thickness of the substrate;
- a plurality of heaters on the substrate for heating the substrate, the plurality of heaters defining a plurality of temperature regions having distinct temperatures, wherein the trench exists between the temperature regions thereby thermally isolating the plurality of heaters on either sides of the trench along a length of the substrate;
- a flow feature layer defining a channel above the substrate between a fluid inlet and outlet disposed at ends of the length of the substrate and having an intermediate portion, the channel extending across the substrate through each temperature region, wherein the channel resides under a cover defining a serpentine path in the intermediate portion having a plurality of cycles along an extent of the serpentine path, wherein the cycles pass through each of the disposed in the cycles along the extent of the serpentine path in the intermediate portion; and
- at least one pump between the fluid inlet and the intermediate portion of the channel but not disposed in any of the temperature regions for pumping fluid in the channel to flow from one temperature region to a next temperature region to allow the fluid to undergo thermal cycling.

2. The device of claim 1, further comprising a heat sink 35 mounted beneath the substrate to collect heat residue between adjacent temperature regions so as to reduce a temperature gradient therebetween.

3. The device of claim **1**, further including one or more wells disposed in said each of the temperature regions.

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